

Form No.: QF-1274

Edition: 2

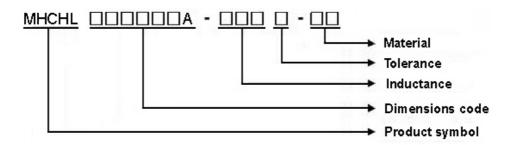
ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

RoHS & Halogen Free & REACH Compliance.

SPECIFICATION FOR APPROVAL

Customer:		
Customer P/N:		
Drowing No :		
Drawing No:		
Quantity:	0 Pcs. Date:	2016/04/15
Chilisin P/N:	MHCHL252010A-	SERIES-Q8
	SPECIFICATION	
	ACCEPTED BY:	
COMPONENT		
ENGINEER		
ELECTRICAL ENGINEER		
MECHANICAL		
ENGINEER		
APPROVED		
REJECTED		
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Drawn by	Checked by	Approved by
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- 1 Scope: This specification applies to Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature: $-40 \,^{\circ}\text{C} \sim 125 \,^{\circ}\text{C}$ (Including self - temperature rise)

Storage Temperature: $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$ (after PCB)

 $-5\,^{\circ}\mathrm{C} \sim 3\,\,5\,^{\circ}\mathrm{C}$, Humidity $4\,\,5\,\% \sim 8\,\,5\,\%$ (before PCB)

4 Marking:

No Marking			

5 Standard Testing Condition

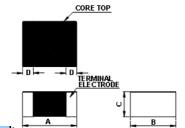
	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35℃)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH



ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

MHCHL252010A Series Specification

6 Configuration and Dimensions:



Dimensions in mm				
TYPE	MHCHL252010A			
Α	2.5 <u>+</u> 0.3			
В	2.0±0.3			
С	1.0 Max.			
D	0.6 <u>+</u> 0.3			

7 Electrical Characteristics:

Part No.	Inductance (uH)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	SRF (MHz)Min.	Tolerance (±%)
MHCHL252010A-R24M-Q8	0.24	2MHz,0.2V	5.5(6.5)	8.0(9.5)	18(13)	126	20
MHCHL252010A-R33M-Q8	0.33	2MHz,0.2V	4.8(5.5)	6.5(8.0)	24(18)	95	20
MHCHL252010A-R47M-Q8	0.47	2MHz,0.2V	3.9(4.5)	5.0(6.2)	35(27)	87	20
MHCHL252010A-R68M-Q8	0.68	2MHz,0.2V	3.7(4.2)	4.5(5.6)	40(32)	53	20
MHCHL252010A-1R0M-Q8	1	2MHz,0.2V	3.0(3.5)	3.7(4.6)	53(45)	41	20
MHCHL252010A-1R5M-Q8	1.5	2MHz,0.2V	2.4(2.8)	3.1(3.8)	75(68)	37	20
MHCHL252010A-2R2M-Q8	2.2	2MHz,0.2V	2.2(2.5)	2.5(3.0)	105(87)	29	20

NOTE:

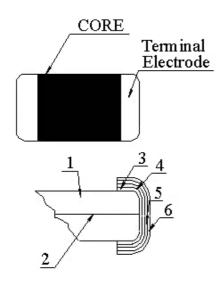
^{2.} Isat for Inductance drop 30% from its value without current.

^{3.}Irms for a $40^\circ\mathbb{C}$ temperature rise from $25^\circ\mathbb{C}$ ambient.



8 MHCHL252010A Series

8.1 Construction:



8.2 Material List:

No	Part	Material
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn



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MHCHL252010A Series Specification 9 Reliability Of Molding power inductors

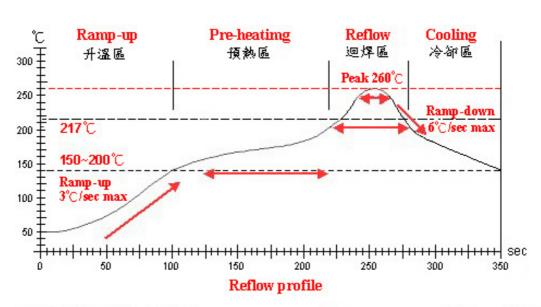
1-1.Mechanical Performance

No	ltem	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right conditions must not damage the terminal electrode and the metal body	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 30sec
1-1-2	Vibration	Appearance:No damage (for microscope of CASTOR MZ-45 20X) Inductance change shall be within ±20%	Test device shall be soldered on the substrate Oscillation Frequency: 10 to 55 to 10 Hz for 1 min Amplitude: 1.5mm Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage More than 75% of the terminal. electrode should be covered with solder. Inductance: within ±20% of initial value	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260±5°C Immersion Time: 10±1sec
1-1-4	Solder ability	The electrodes shall be at least 95% covered with new solder coating	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0,5(Pb-Free) Solder Temperature: 245±5°C Immersion Time: 4±1sec
1-1-5	Terminal Strength Test	No split termination Chip F Mounting Pad	Test device shall be soldered on the substrate then apply a force in the direction of the arrow. Force: 5N Keeping Time: 10±1sec

1-2 Environmental Performance

No	Item	Specification		Test Method			
1-2-1	Temperature Cycle	Appearance: No damage	One cycle:				
		Inductance:within±20% of	Step	Temperature (°C)		Time (min)	
		initial value	1	-40±3		30	
			2	25±2		3	
			3	125±3		__ 30	
			4	25±2	4	3	
			Total: 100d	cycles	l'	J	
			Measured	after exposure in the room co	ndi	tion for 24hrs	
1-2-2	1-2-2 Humidity Resistance		Humidity Resistance	Temperatu	ıre: 60±2°C		
			Relative H	umidity: 90 ~ 95% / Time: 5 <mark>0</mark>	Ohrs	3	
			Measured	after exposure in the room co	ndi	tion for 24hrs	
1-2-3	High		Temperatu	ıre: 85±3℃	√'		
	Temperature Resistance		Relative H	umidity: 0% / Time: 500hrs	'		
			Measured	after exposure in the room co	ndi	tion for 24hrs	
1-2-4	Low		Temperatu	ıre: -40±3°C			
	Temperature Resistance		Relative H	umidity: 0% / Time: 500hrs			
			Measured	after exposure in the room co	ndi	tion for 24hrs	





Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷部區 Cooling
溫度範圍 Temp.scope	R.T. ~150°C	150°C ~ 200°C	217℃	260±5°C	Peak Temp. ~ 150°C
標準時間 Time spec.	_	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	-
實際時間 Time result	_	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	/

NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow



10 Packaging:

10.1 Packaging -Cover Tape

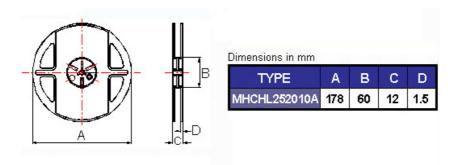
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



10.2 Packaging Quantity

TYPE	PCS/REEL
MHCHL252010A	3000

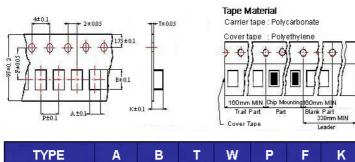
10.3 Reel Dimensions





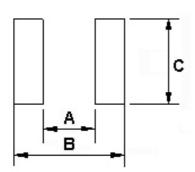
10 Packaging:

10.4 Tape Dimensions in mm



MHCHL252010A 2.25 2.8 0.22 8 4 3.5 1.15

11 Recommended Land Pattern:



Dimensions in mm

TYPE	Α	В	O
MHCHL252010A	1.2	2.8	2.3

12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglected
- 6. The moisture sensitivity level (MSL) of products is classified as level 1.

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CR54NP-820KC CR54NP-8R5MC 70F224AI MGDQ4-00004-P MHL1ECTTP18NJ MHQ1005P10NJ MHQ1005P1N0S MHQ1005P2N4S
MHQ1005P3N6S MHQ1005P5N1S MHQ1005P8N2J PE-51506NL PE-53601NL PE-53602NL PE-53630NL PE-53824SNLT PE-92100NL
PG0434.801NLT PG0936.113NLT 9220-20 9310-16 PM06-2N7 PM06-39NJ A01TK 1206CS-471XJ HC2LP-R47-R HC2-R47-R HC32R2-R HCF1305-3R3-R 1206CS-151XG RCH664NP-140L RCH664NP-4R7M RCH8011NP-221L RCP1317NP-332L RCP1317NP-391L